

NCE01P30

NCE P-Channel Enhancement Mode Power MOSFET

Description

The NCE01P30 uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications. It is ESD protested.

General Features

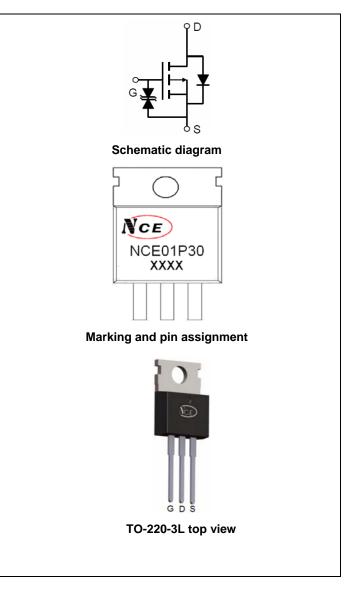
- V_{DS} =-100V, I_{D} =-30A $R_{DS(ON)}$ <58mΩ @ V_{GS} =-10V (Typ:50mΩ)
- Super high dense cell design
- Advanced trench process technology
- Reliable and rugged
- High density cell design for ultra low On-Resistance

Application

Portable equipment and battery powered systems

100% UIS TESTED!

100% ΔVds TESTED!



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE01P30	NCE01P30	TO-220-3L	-	-	-

Absolute Maximum Ratings (T_C=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	-100	V
Gate-Source Voltage	V _G s	±20	V
Drain Current-Continuous	I _D	-30	Α
Drain Current-Continuous(T _C =100 °C)	I _D (100℃)	-21	Α
Pulsed Drain Current	I _{DM}	-120	Α
Maximum Power Dissipation	P _D	120	W
Derating factor		0.8	W/℃
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 175	${\mathbb C}$



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NCE01P30

Thermal Characteristic

Electrical Characteristics (T_C=25 °C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	<u>.</u>		•			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250μA	-100	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-100V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±10	μA
On Characteristics (Note 3)						
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=-250\mu A$	-1.5	-1.9	-2.5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-10V, I _D =-15A	-	50	58	mΩ
Forward Transconductance	g FS	V _{DS} =-50V,I _D =-10A	5	-	-	S
Dynamic Characteristics (Note4)			•			
Input Capacitance	C _{lss}	\/ - 25\/\/ -0\/	-	2700	-	PF
Output Capacitance	Coss	V_{DS} =-25V, V_{GS} =0V, F=1.0MHz	-	790	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.UIVID2	-	450	-	PF
Switching Characteristics (Note 4)			•			
Turn-on Delay Time	t _{d(on)}		-	17	-	nS
Turn-on Rise Time	t _r	V _{DD} =-50V,I _D =-15A	-	80	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =-10 V , R_{GEN} =9.1 Ω	-	45	-	nS
Turn-Off Fall Time	t _f		-	65	-	nS
Total Gate Charge	Qg	\/ - F0\/ - 45A	-	90	-	nC
Gate-Source Charge	Q _{gs}	V_{DS} =-50V, I_{D} =-15A, V_{GS} =-10V	-	15	-	nC
Gate-Drain Charge	Q_{gd}	V _{GS} 10V	-	35	-	nC
Drain-Source Diode Characteristics			•			
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-10A	-	-	-1.2	V
Diode Forward Current (Note 2)	Is	-	-	-	-30	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF =-15A	-	90	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	70	-	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

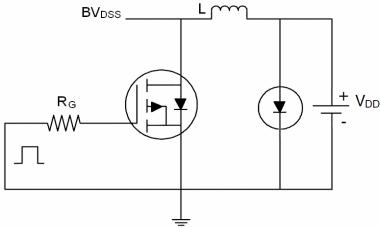
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- **5.** EAS condition: Tj=25 $^{\circ}$ C,V_{DD}=-50V,V_G=-10V,L=0.5mH,Rg=25 Ω

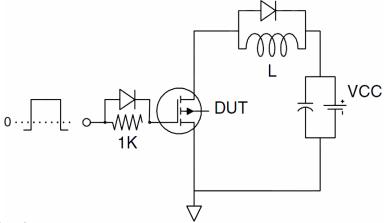


Test Circuit

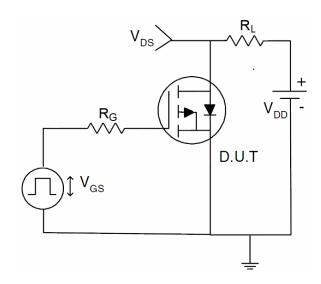
1) E_{AS} Test Circuit



2) Gate Charge Test Circuit



3) Switch Time Test Circuit





Typical Electrical and Thermal Characteristics (Curves)

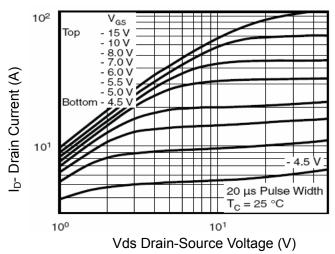


Figure 1 Output Characteristics

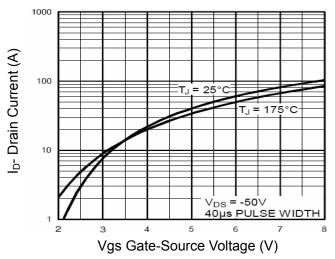


Figure 2 Transfer Characteristics

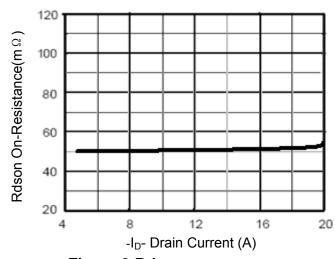


Figure 3 Rdson- Drain Current

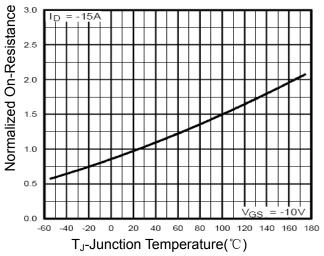


Figure 4 Rdson-JunctionTemperature

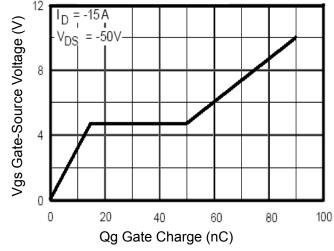


Figure 5 Gate Charge

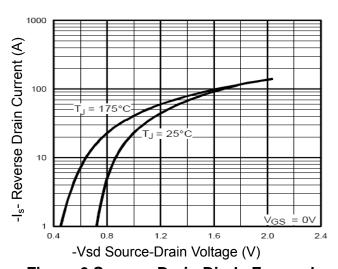
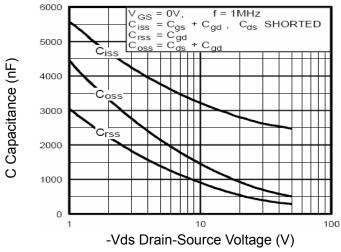


Figure 6 Source- Drain Diode Forward

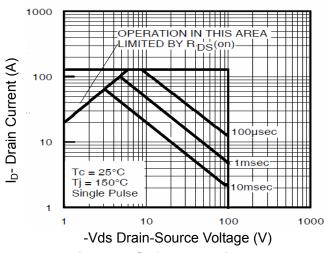




(V) 30 20 20 20 20 25 50 75 100 125 150 175 T_C Case Temperature(°C)

Figure 7 Capacitance vs Vds

Figure 9 Drain Current vs Case Temperature



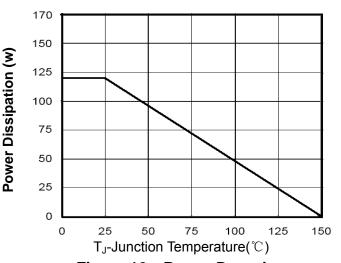


Figure 8 Safe Operation Area

Figure 10 Power De-rating

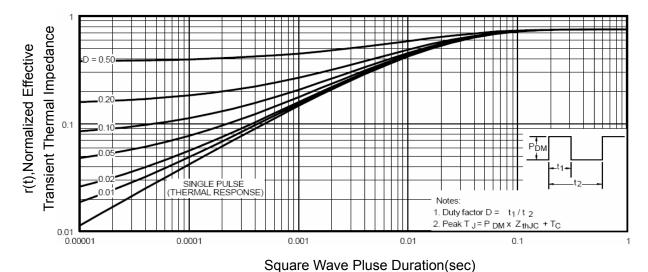
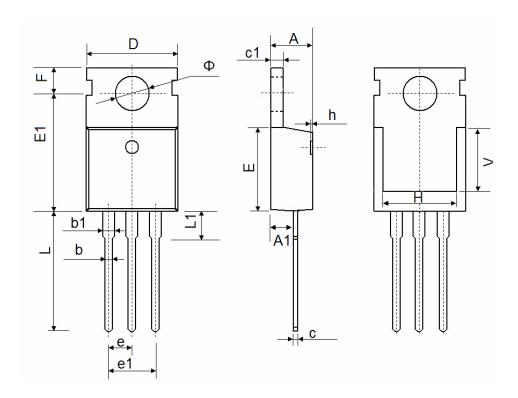


Figure 11 Normalized Maximum Transient Thermal Impedance

Pb Free Product

NCE01P30

TO-220-3L Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
Α	4.400	4.600	0.173	0.181	
A1	2.250	2.550	0.089	0.100	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.330	0.650	0.013	0.026	
c1	1.200	1.400	0.047	0.055	
D	9.910	10.250	0.390	0.404	
E	8.9500	9.750	0.352	0.384	
E1	12.650	12.950	0.498	0.510	
е	2.540 TYP.		0.100 TYP.		
e1	4.980	5.180	0.196	0.204	
F	2.650	2.950	0.104	0.116	
Н	7.900	8.100	0.311	0.319	
h	0.000	0.300	0.000	0.012	
L	12.900	13.400	0.508	0.528	
L1	2.850	3.250	0.112	0.128	
V	7.500 REF.		0.295 REF.		
Ф	3.400	3.800	0.134	0.150	



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